STW35N60DM2



N-channel 600 V, 0.094 Ω typ., 28 A MDmesh[™] DM2 Power MOSFET in a TO-247 package

Datasheet - production data

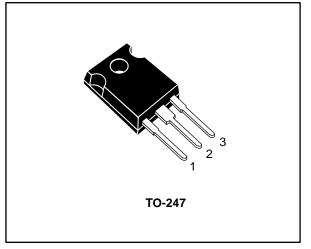
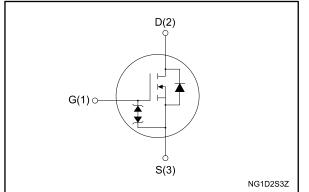


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ртот
STW35N60DM2	600 V	0.110 Ω	28 A	210 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmeshTM DM2 fast recovery diode series. It offers very low recovery charge (Q_{rr}) and time (t_{rr}) combined with low $R_{DS(on)}$, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STW35N60DM2	35N60DM2	TO-247	Tube

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	±25	V
	Drain current (continuous) at T _{case} = 25 °C	28	٨
Ι _D	Drain current (continuous) at T _{case} = 100 °C	17	A
I _{DM} ⁽¹⁾	Drain current (pulsed)	112	А
P _{TOT}	Total dissipation at T _{case} = 25 °C	210	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns
T _{stg}	Storage temperature	-55 to 150	°C
Tj	Operating junction temperature	-55 10 150	C

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ I_{SD} ≤ 28 A, di/dt=900 A/µs; V_{DS} peak < V_{(BR)DSS}, V_{DD} = 400 V

⁽³⁾ $V_{DS} \le 480 \text{ V}.$

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.6	9 0 A A/
R _{thj-amb}	Thermal resistance junction-amb	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive	6	А
E _{AS} ⁽¹⁾	Single pulse avalanche energy	650	mJ

Notes:

 $^{(1)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

 $(T_{case} = 25 \text{ °C unless otherwise specified})$

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	600			V
	Zoro goto voltago droin	$V_{GS} = 0 V, V_{DS} = 600 V$			10	
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 V$, $V_{DS} = 600 V$, $T_{case} = 125 $ °C			100	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±25 V			±5	μA
V _{GS(th)}	Gate threshold voltage	$V_{\text{DS}} = V_{\text{GS}}, \ I_{\text{D}} = 250 \ \mu\text{A}$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, I_D = 14 \text{ A}$		0.094	0.11	Ω

Table 6: Dynamic							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
C _{iss}	Input capacitance		-	2400	-		
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	-	110	-	pF	
C _{rss}	Reverse transfer capacitance		-	2.8	-		
C _{oss}	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	190	-	pF	
R _G	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	4.3	-	Ω	
Qg	Total gate charge		-	54	-		
Q _{gs}	Gate-source charge	V_{DD} = 480 V, I_D = 28 A, V_{GS} = 10 V (see Figure 15: "Test circuit for gate charge behavior")	-	14.6	-	nC	
Q _{gd}	Gate-drain charge		-	24.2	-		

Notes:

 $^{(1)}$ $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% $V_{DSS}.$

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	V_{DD} = 300 V, I_D = 14 A R _G = 4.7 Ω , V _{GS} = 10 V (see <i>Figure 14: "Test circuit for</i> <i>resistive load switching times"</i> and <i>Figure 19:</i> <i>"Switching time waveform"</i>)	-	21.2	-		
tr	Rise time		-	17	-		
$t_{d(off)}$	Turn-off delay time		-	68	-	ns	
t _f	Fall time		-	10.7	-		

Table 7: Switching times

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Electrical characteristics

	Table 8: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
I _{SD}	Source-drain current		-		28	А		
Isdm ⁽¹⁾	Source-drain current (pulsed)		-		112	A		
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 28 A$	-		1.6	V		
t _{rr}	Reverse recovery time	$I_{SD} = 28 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, V_{DD} = 60 \text{ V}$ (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	120		ns		
Q _{rr}	Reverse recovery charge		-	572		nC		
I _{RRM}	Reverse recovery current		-	10.2		A		
t _{rr}	Reverse recovery time		-	215		ns		
Q _{rr}	Reverse recovery charge	I_{SD} = 28 A, di/dt = 100 A/µs, V _{DD} = 60 V, T _j = 150 °C (see Figure 16: "Test circuit for inductive load switching and diode	-	1.89		μC		
I _{RRM}	Reverse recovery current	recovery times")	-	17.7		А		

Notes:

⁽¹⁾ Pulse width is limited by safe operating area.

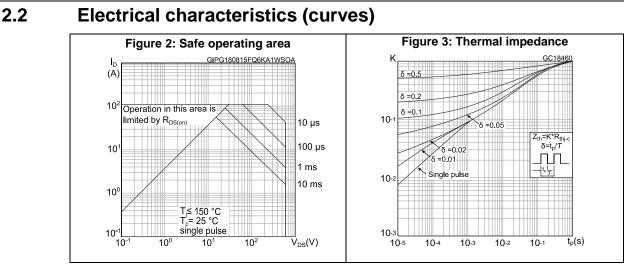
 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.

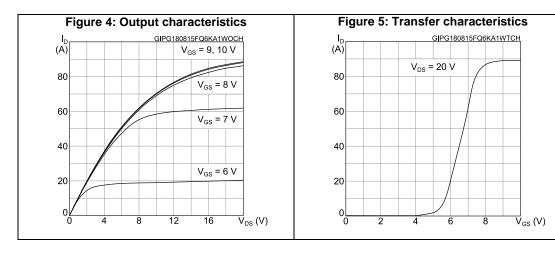
Table 9: Gate-source Zener diode

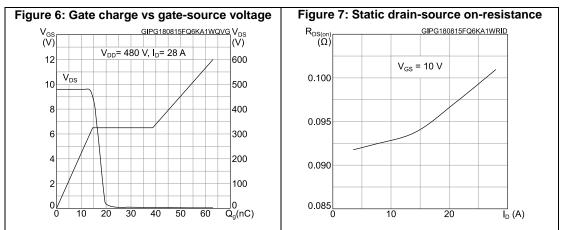
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	$I_{GS} = \pm 250 \ \mu A, I_D = 0 \ A$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.





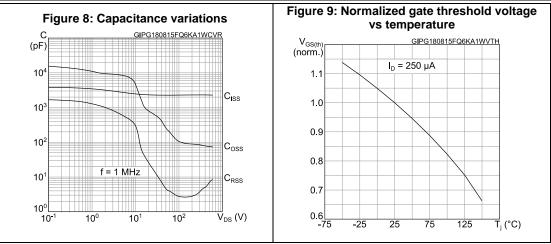


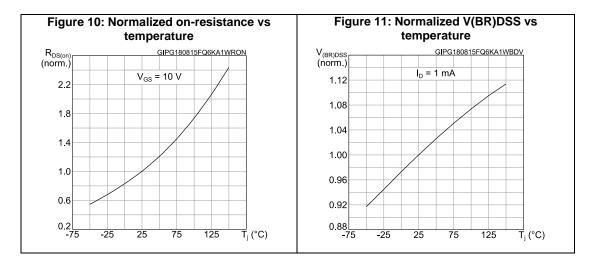


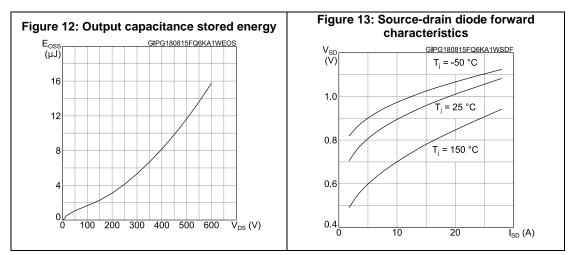


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Electrical characteristics

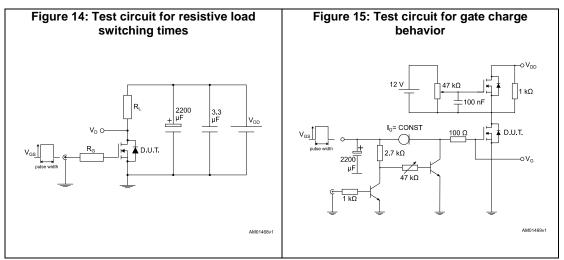


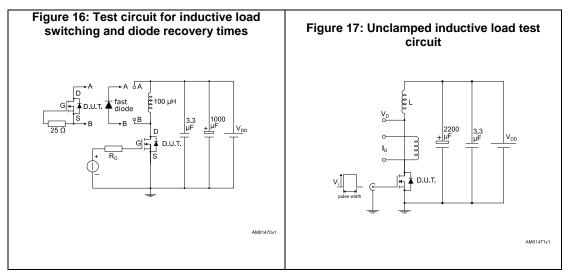


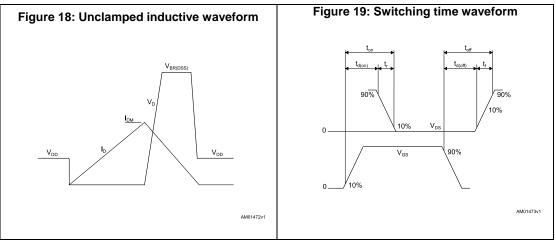


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3 Test circuits







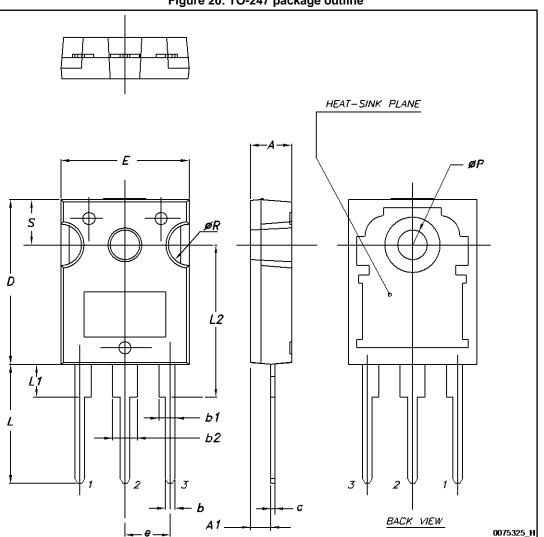
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Package information 4

In order to meet environmental requirements, ST offers these devices in different grades of $ECOPACK^{\$}$ packages, depending on their level of environmental compliance. $ECOPACK^{\$}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

4.1 **TO-247** package information







Package information

STW35N60DM2

nformation			51W35N60DM2	
Table 10: TO-247 package mechanical data				
Dim.	mm.			
	Min.	Тур.	Max.	
А	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	

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5 Revision history

Table 11: Document revision history

Date	Revision	Changes
02-Sep-2015	1	Initial version



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